



Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of “Quality Parts,Customers Priority,Honest Operation,and Considerate Service”,our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



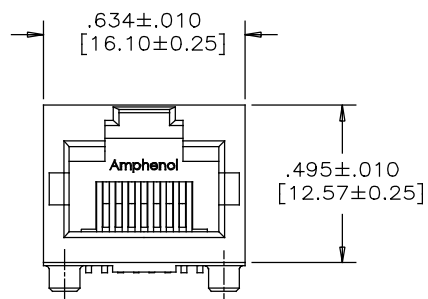
## Contact us

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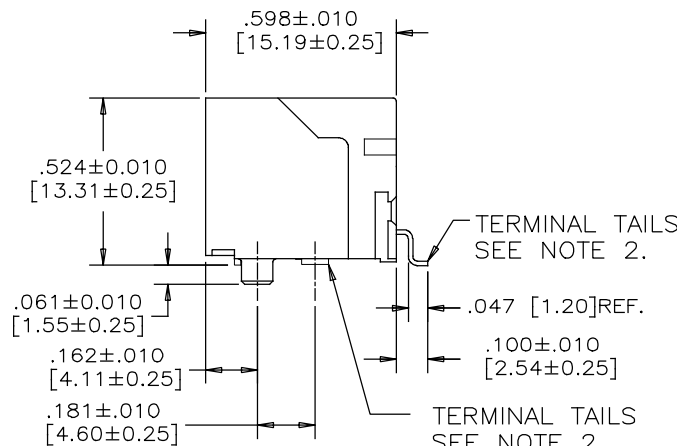
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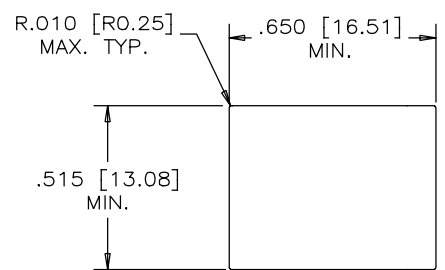


FRONT VIEW

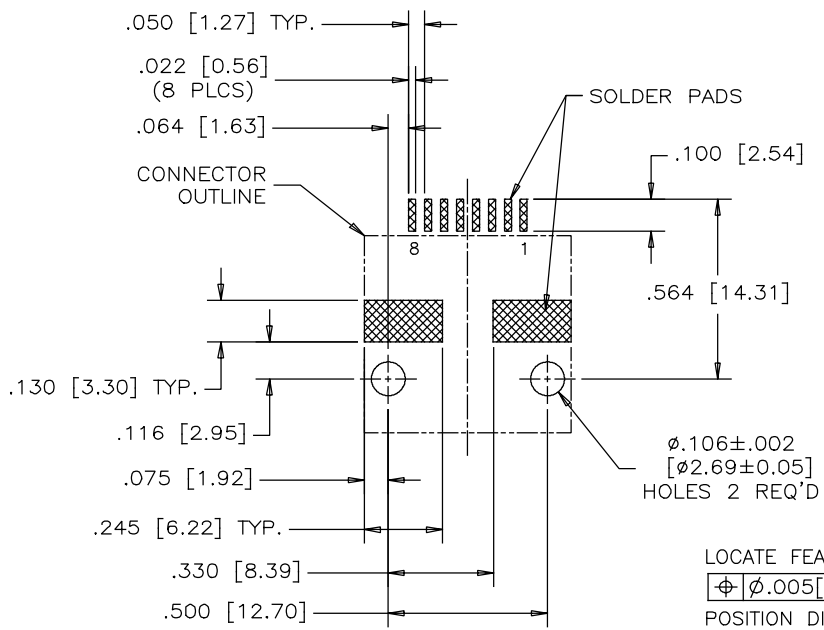


SIDE VIEW

REVISIONS				
SYM	ZONE	ECN, ERN NO.	DATE	APPRD.
B	E07099	CHANGE CONTACT TAIL FORMING FIGURE	APR.13.07	LCHAN
C	E07166	ADD COPLANARITY	MAY 23/07	LCHAN
D	E07215	PER ECN E07215	JUL 11/07	LCHAN
E	E07389	PER ECN E07389	NOV 06/07	LCHAN
F		ADD BOARDLOCK LENGTH	MAY 30/13	LCHAN
G		CORRECT DIMENSION	NOV 06/15	LCHAN
H		CORRECT DIMENSION	JAN 18/16	LCHAN



RECOMMENDED PANEL CUTOUT



RECOMMENDED P.C.B. LAYOUT  
(COMPONENT SIDE OF BOARD)



NOTES

1. MATERIAL:

HOUSING: HIGH TEMPERATURE THERMOPLASTIC  
FLAMMABILITY RATING UL 94V-0  
COLOR:BLACK

CONTACTS: PHOSPHOR BRONZE  
PLATING: 20 μ" [0.508 MICRONS]  
MIN. GOLD ON MATING SURFACES.  
50 μ" [1.27 MICRONS]  
MIN. NICKEL UNDERPLATE  
100 μ" [2.54 MICRONS]  
MIN. MATTE TIN OR GOLD FLASH  
ON CONTACT TAILS.

2. COPLANARITY SPECIFICATION:  
WITH THE MODULAR JACK SITTING ON A  
LEVEL SURFACE, THE MAXIMUM GAP BETWEEN  
THE LEVEL SURFACE AND ALL TERMINAL TAILS  
AND BOTH FITTING NAILS IS .004 [0.10].

SUITABLE FOR SOLDERING IN ACCORDANCE JEDEC-020C STANDARD.  
AMPHENOL PART NUMBER: RJ SSE-5080

THIS DOCUMENT CONTAINS PROPRIETARY INFORMATION AND SUCH INFORMATION  
MAY NOT BE DISCLOSED TO OTHERS FOR ANY PURPOSE OR USED FOR MANUFACTURING  
PURPOSES WITHOUT WRITTEN PERMISSION FROM AMPHENOL CANADA CORP.

MATERIAL	DRAWN	Chigow Xu	DATE	APR.06.07	Amphenol Canada Corp.							
	DESIGNED											
FINISH	CHECKED	LCHAN	APR.06.07	TITLE SURFACE MOUNT, RJ45 8 POSITION, 8 CONTACTS, WITHOUT SHIELD, TRAY PACKAGING-RoHS COMPLIANT								
	I. E. APPRD.	YM	APR.06.07									
	Q. A. APPRD.	KENT.Y	MAY 23/07									
	DWG. APPRD.											
	ENG. REL. NO. ECN	E07099						DWG	DRAWING NO.	P-RJSSE-5080	REV.	H
	REF. EAR:	RJ13074						C				
DIMENSIONS ARE IN		CODE ID. NO.	03554	SCALE 2:1		WT. -----	SURF. -----	SHEET 1 OF 1				
		INCHES	[mm]									